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# 2.5V Drive Nch MOS FET

### 2SK3018

#### Structure

Silicon N-channel **MOSFET** 

#### Applications

Interfacing, switching (30V, 100mA)

#### Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Low voltage drive (2.5V) makes this device ideal for portable equipment.
- 4) Drive circuits can be simple.
- 5) Parallel use is easy.

#### Packaging specifications

Туре	Package	Taping
	Code	T106
	Basic ordering unit (pieces)	3000
2SK301	8	0

#### Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit	
Drain-source voltage	VDSS	30	V	
Gate-source voltage	Vgss	±20	V	
Drain current	Continuous	lo	±100	mA
Drain current	Pulsed	IDP*1	±400	mA
Total power dissipatio	P <sub>D</sub> *2	200	mW	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

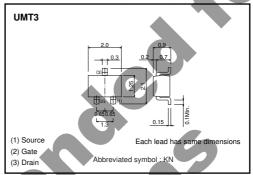
- **\***1 Pw≤10μs, Duty cycle≤1%
- \*2 With each pin mounted on the recommended lands.

#### ●Thermal resistance

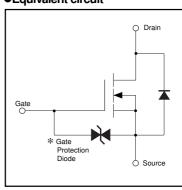
Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a) *	625	°C / W

\* With each pin mounted on the recommended lands.

#### ●External dimensions (Unit : mm)



#### ●Equivalent circuit



\*A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use a protection circuit when the fixed voltages are exceeded.

#### ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	_	-	±1	μΑ	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	30	_	_	V	$I_D = 10\mu A$ , $V_{GS} = 0V$
Zero gate voltage drain current	IDSS	_	-	1	μА	$V_{DS} = 30V$ , $V_{GS} = 0V$
Gate threshold voltage	V <sub>GS(th)</sub>	0.8	_	1.5	V	$V_{DS} = 3V, I_{D} = 100 \mu A$
Static drain-source on-state	RDS(on)	_	5	8	Ω	ID = 10mA, VGS = 4V
resistance	RDS(on)	_	7	13	Ω	I <sub>D</sub> = 1mA, V <sub>G</sub> s = 2.5V
Forward transfer admittance	Yfs	20	_	_	mS	V <sub>DS</sub> = 3V, I <sub>D</sub> = 10mA
Input capacitance	Ciss	_	13	_	pF	V <sub>DS</sub> = 5V
Output capacitance	Coss	_	9	_	pF	V <sub>G</sub> S = 0V
Reverse transfer capacitance	Crss	_	4	_	pF	f = 1MHz
Turn-on delay time	td(on)	-	15	-	ns	$I_D = 10 \text{mA}, V_{DD} = 5V$
Rise time	tr	_	35	_	ns	Vgs = 5V
Turn-off delay time	td(off)	_	80	_	ns	$R_L = 500\Omega$
Fall time	tf	_	80	_	ns	$R_G = 10\Omega$

#### •Electrical characteristic curves

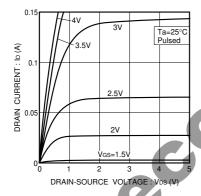


Fig.1 Typical output characteristics

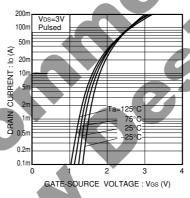


Fig.2 Typical transfer characteristics

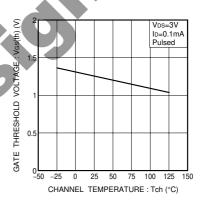


Fig.3 Gate threshold voltage vs. channel temperature

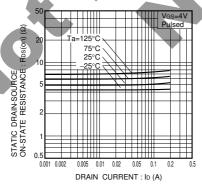


Fig.4 Static drain-source on-state resistance vs. drain current ( I )

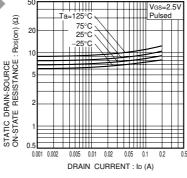


Fig.5 Static drain-source on-state resistance vs. drain current (II)

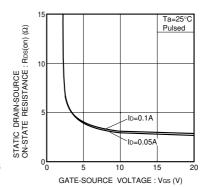


Fig.6 Static drain-source on-state resistance vs. gate-source voltage

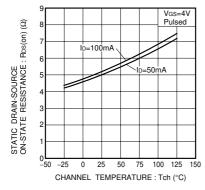


Fig.7 Static drain-source on-state resistance vs. channel temperature

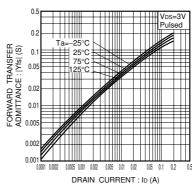


Fig.8 Forward transfer admittance vs. drain current

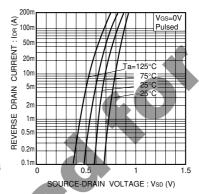


Fig.9 Reverse drain current vs. source-drain voltage (I)

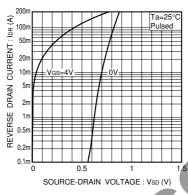


Fig.10 Reverse drain current vs. source-drain voltage (II)

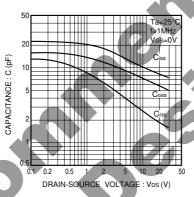


Fig.11 Typical capacitance vs. drain-source voltage

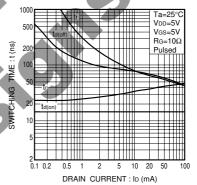


Fig.12 Switching characteristics (See Figures 13 and 14 for the measurement circuit and resultant waveforms)

#### Switching characteristics measurement circuit

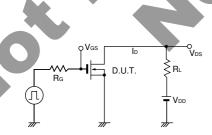


Fig.13 Switching time measurement circuit

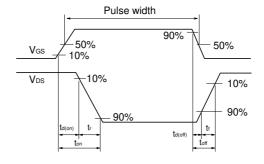


Fig.14 Switching time waveforms

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